Ma Mas4927 Na

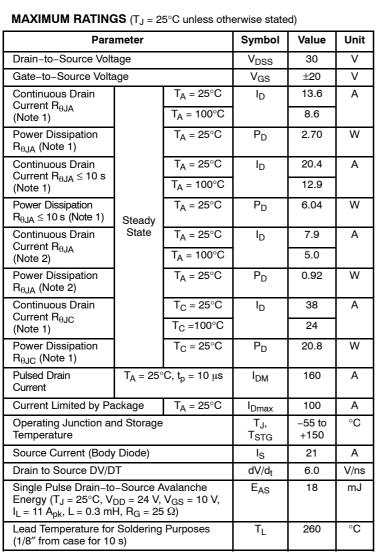
Power MOSFET 30 V, 38 A, Single N–Channel, SO–8 FL

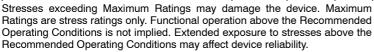
Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters





1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

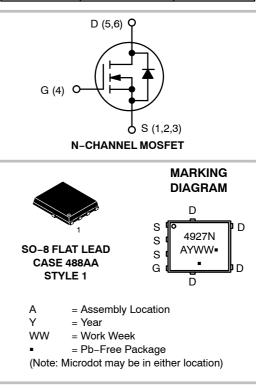
2. Surface-mounted on FR4 board using the minimum recommended pad size.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	9.0 mΩ @ 10 V	38 A
30 V	13.5 mΩ @ 4.5 V	30 A



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4927NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4927NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

查時中WAMRESISTANGE州应樹UM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ ext{ heta}JC}$	6.0	
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	46.3	°C/W
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	136.2	C/VV
Junction-to-Ambient – (t \leq 10 s) (Note 3)	R_{\thetaJA}	20.7	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS				-	-	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D =$	= 250 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				24		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	
		V _{DS} = 24 V	T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V				±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.2	1.6	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	on) V _{GS} = 10 V	I _D = 30 A		5.4	9.0	
			I _D = 15 A		5.3		
		V _{GS} = 4.5 V	I _D = 30 A		8.9	13.5	mΩ
			I _D = 15 A		8.5		
Forward Transconductance	9 FS	V _{DS} = 1.5 V, I _D = 15 A			40		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE			•	•	•	•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 15 V			913		
Output Capacitance	C _{OSS}				366		pF
	-					1	1

Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	366	pF
Reverse Transfer Capacitance	C _{RSS}		108	
Total Gate Charge	Q _{G(TOT)}		8.0	
Threshold Gate Charge	Q _{G(TH)}		1.6	nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A	3.1	nc
Gate-to-Drain Charge	Q _{GD}		3.1	
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V; I_{D} = 30 A	16.0	nC

SWITCHING CHARACTERISTICS (Note 6)

Turn-On Delay Time	t _{d(ON)}		9.2	
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 15 V,	25.5	20
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 15 {\rm A}, {\rm R}_{\rm G} = 3.0 {\Omega}$	14.0	ns
Fall Time	t _f		4.4	

 $\begin{array}{ll} \text{5. Pulse Test: pulse width} \leq 300 \ \mu\text{s} \text{, duty cycle} \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$

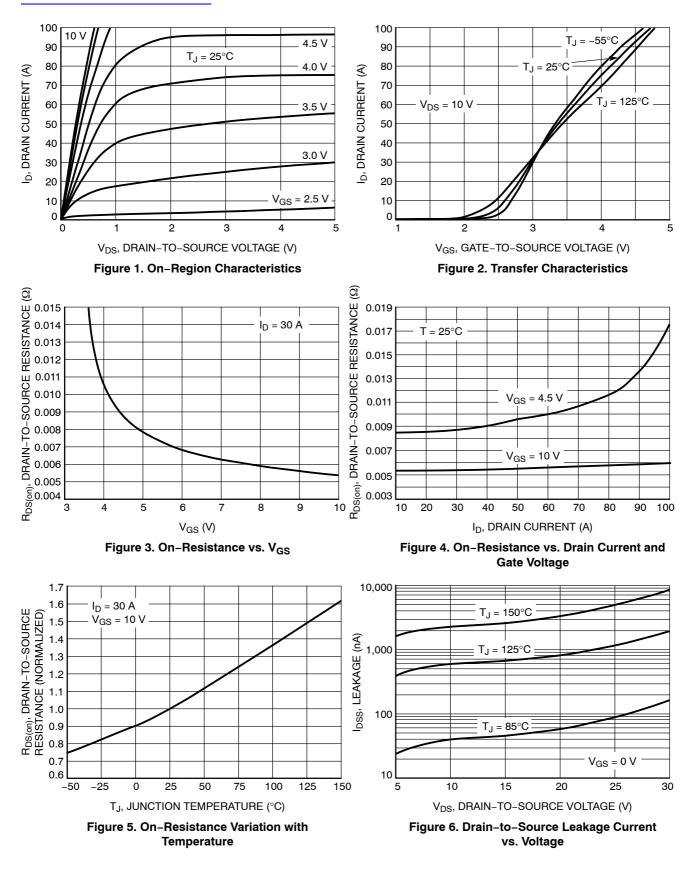
ZEVECTRICAL CHARACTERISTICS (TJ = 25°C unless otherwise specified)

Parameter	Symbol	Test Con	Min	Тур	Max	Unit	
SWITCHING CHARACTERISTICS (No	ote 6)			-	-		
Turn-On Delay Time	t _{d(ON)}			6.5			
Rise Time	t _r	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			21.0		ns
Turn-Off Delay Time	t _{d(OFF)}				18.0		
Fall Time	t _f				3.0		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$		0.87	1.1	v	
		T _J = 125°C		0.76			
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 30 A			21.4		
Charge Time	t _a				10.5		ns
Discharge Time	t _b				10.9		
Reverse Recovery Charge	Q _{RR}				8.4		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				1.00		nH
Drain Inductance	L _D				0.005		nH
Gate Inductance	L _G				1.84		nH
Gate Resistance	R _G				0.90	2.2	Ω

 $\begin{array}{lll} \text{5. Pulse Test: pulse width } \leq 300 \ \mu\text{s} \text{, duty cycle } \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$

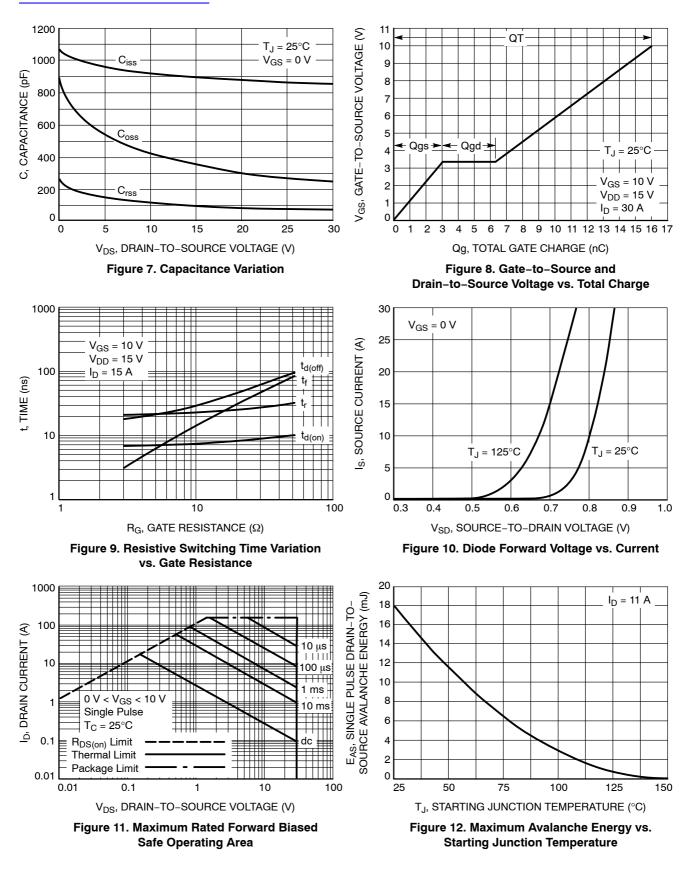
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TYPICAL CHARACTERISTICS



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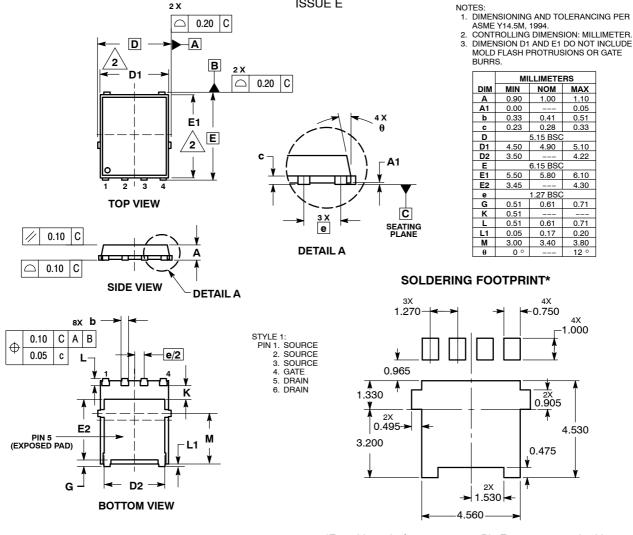
TYPICAL CHARACTERISTICS



查询"NTMFS4927-D"供应商

PACKAGE DIMENSIONS

DFN5 5x6, 1.27P (SO8 FL) CASE 488AA-01 ISSUE E



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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